503198906 02/27/2015

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
DAE SUK KIM	02/09/2015

RECEIVING PARTY DATA

Name:	SK HYNIX INC.	
Street Address:	2091, GYEONGCHUNG-DAERO, BUBAL-EUB	
City:	ICHEON-SI GYEONGGI-DO	
State/Country: KOREA, REPUBLIC OF		

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14634167

CORRESPONDENCE DATA

Fax Number: (630)908-7653

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 6309087652

Email: uspto.actions@wpapat.com

Correspondent Name: WILLIAM PARK & ASSOCIATES PATENT LTD.

Address Line 1: 930 N. YORK ROAD, SUITE 201 Address Line 4: HINSDALE, ILLINOIS 60521

TTORNEY DOCKET NUMBER: PA2101-0		
NAME OF SUBMITTER: WOOCHOON W. PARK		
SIGNATURE:	/Woochoon W. Park/	
DATE SIGNED:	02/27/2015	
This document serves as an Oath/Declaration (37 CFR 1.63).		

Total Attachments: 1

source=PA2101-0 Declaration Assignment#page1.tif

PATENT REEL: 035055 FRAME: 0804 503198906

DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT

Title of invention	INPUT CIRCUIT OF SEMICONDUCTOR APPARATUS AND SEMICONDUCTOR SYSTEM USING THE SAME		
Declaration	As the below named inventor(s), I h The declaration is directed to: The attached application,		
	PGT/KR######### filed or	\$	
a salan a sala		s made or authorized to be made by me	
	application.	in original joint inventor of a claimed invention in the	
	I hereby acknowledge that any punishable under 18 U.S.C. 1001 by or both.	willful false statement made in this declaration is fine or imprisonment of not more than five (5) years	
		ion of the sum of one dollar (\$1), the receipt whereof valuable consideration, I, by these presents do sell, is(s)	
		SK hynix Inc.	
	and the second s	il-eub, icheon-si, Gyeonggi-do, Republic of Korea	
Assignment	and the heirs, successors, assigns and legal representatives of the assignee(s) the full and exclusive right to the said invention in the United States and in its territorial possessions and in any and all foreign countries any and all improvements thereof, the entire rights, title and interest in and to any and all Patents which may be granted therefore in the United States. I hereby authorize and request the Director of the U.S. Patent and Trademark Office to issue said United States Patent to said assignee(s), of the entire right, title, and interest in and to the same, for his sole use and for the use of his legal representatives, to the full end of the term for which said Patent may be granted, as fully and entirely as the same would have been held by me had this assignment and sale not been made.		
	I agree promptly upon request of the assignee(s), its heirs, successors, assigns and legal representatives of the assignee(s) to communicate any facts known to it respecting the patent and the invention set forth therein, and to execute and deliver without further compensation any power of attorney. Assignment, application, whether original continuation, divisional or reissue, or other papers that may be necessary.		
		ent, sale agreement or encumbrance has been or will conflict with this assignment and sale.	
	I further coverant that assignes(s) will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to me and will testify as to the same in any litigation related thereto and will properly execute and deliver to assignes(s) or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.		
Legal Name Of Inventor	Inventor Name (First Middle LAST):	Dae Suk KIM	
	Inventor Signature:	44E 598 KC4	
	Date:	2015, 2.9	

A total of __supplemental sheet(s) are attached hereto for additional inventors, if any.

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